

# STB10NK60Z, STP10NK60Z STW10NK60Z

N-channel 650 V, 0.65 Ω, 10 A, SuperMESH<sup>™</sup> Power MOSFET Zener-protected I<sup>2</sup>PAK, D<sup>2</sup>PAK, TO-220, TO-220FP, TO-247

### Features

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub> max	ID	P <sub>w</sub>
STB10NK60Z-1	600 V	< 0.75 Ω	10 A	115 W
STB10NK60Z	600 V	< 0.75 Ω	10 A	115 W
STP10NK60Z	600 V	< 0.75 Ω	10 A	115 W
STP10NK60ZFP	600 V	< 0.75 Ω	10 A	35 W
STW10NK60Z	600 V	< 0.75 Ω	10 A	156 W

- Extremely high dv/dt capability
- 100% avalanche tested
- Gate charge minimized
- Very good manufacturing reliability

### Application

Switching applications

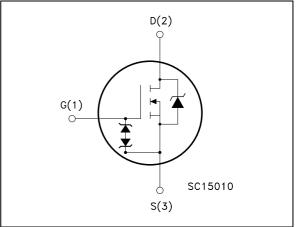
## Description

The SuperMESH<sup>™</sup> series is obtained through an extreme optimization of ST's well established strip-based PowerMESH<sup>™</sup> layout. In addition to pushing on-resistance significantly down, special care is taken to ensure a very good dv/dt capability for the most demanding applications.

Table 1.	Device summary

TO-247		12 <sup>3</sup> TO-262
	TO-263	
TO-220FP		TO-220

Figure 1. Internal schematic diagram



Order codes	Marking	Package	Packaging
STB10NK60Z-1	B10NK60Z	I <sup>2</sup> PAK	Tube
STB10NK60ZT4	B10NK60Z	D <sup>2</sup> PAK	Tape & reel
STP10NK60ZFP	P10NK60ZFP	TO-220FP	Tube
STP10NK60Z	P10NK60Z	TO-220	Tube
STW10NK60Z	W10NK60Z	TO-247	Tube

November 2008

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## 1 Electrical ratings

Table 2.	Absolute maximum ratings
	Aboolate maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage ( $V_{GS} = 0$ )	30	V
V <sub>GS</sub>	Gate-source voltage	±20	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	80	Α
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 100 °C	80	Α
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	320	А
P <sub>TOT</sub>	Total dissipation at $T_C = 25 \ ^{\circ}C$	300	W
	Derating factor	2	W/°C
dv/dt <sup>(3)</sup>	Peak diode recovery voltage slope	2	V/ns
E <sub>AS</sub> <sup>(4)</sup>	Single pulse avalanche energy	2.3	J
T <sub>stg</sub> Tj	Storage temperature Operating junction temperature	-60 to 175	°C

1. Limited by package

2. Pulse width limited by safe operating area

3. I\_{SD}  $\,$  80 A, di/dt  $\,$  240 A/µs, V\_{DD}  $\,$  V<sub>(BR)DSS,</sub> T<sub>J</sub>  $\,$  T<sub>JMAX</sub>

4. Starting Tj = 25 °C,  $I_D$  = 80 A,  $V_{DD}$  = 50 V

Table 3. Thermal resistance	Table 3.	Thermal resistance
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Symbol	Parameter	Value	Unit
Rthj-case	Thermal resistance junction-case max	0.5	°C/W
Rthj-amb	Thermal resistance junction-ambient max62.5		°C/W
Τ <sub>Ι</sub>	Maximum lead temperature for soldering purpose	300	°C



 $\delta = t_p / \tau$ 

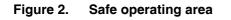
10<sup>0</sup>

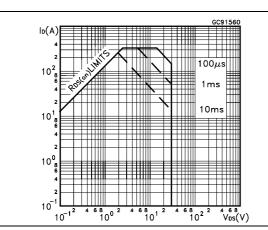
80ТО

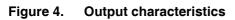
 $Z_{th} = k R_{thJ-c}$ 

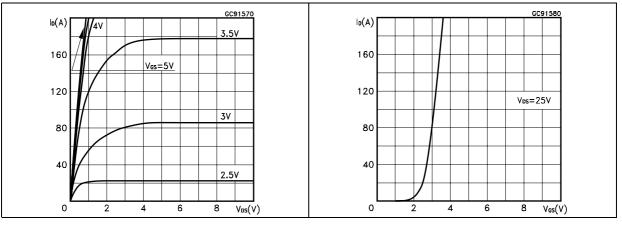
† p (s)

#### **Electrical characteristics (curves)** 2.1

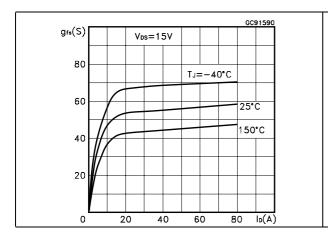














**Thermal impedance** 

0.02

0.01

10-3

SINGLE PULSE

10-4

10-1

10-2

**Transfer characteristics** 

Figure 3.

 $\delta = 0.5$ 

0.2

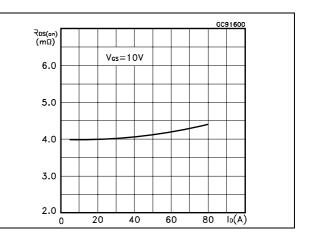
0.1

к

10 -

10 -2 -5

Figure 5.





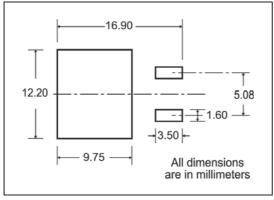
## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.



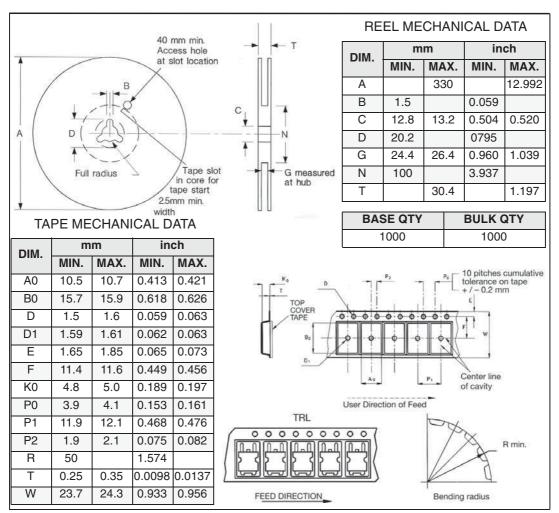
## 5 Packaging mechanical data





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### TAPE AND REEL SHIPMENT



# 6 Revision history

Table 10. Revision history
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Date	Revision	Changes
29-Sep-2005	6	Inserted ecopack indication
29-Oct-2005	7	New value inserted in <i>Table 6</i>
11-Apr-2006	8	New template
19-Sep-2006	9	Unit changed in <i>Table 5</i>
17-Nov-2008	10	Updated Section 4: Package mechanical data



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